### 502697622 02/26/2014

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

# **CONVEYING PARTY DATA**

Name	Execution Date
JACK CONWAY KITCHENS II	01/24/2014
JOHN KEITH SCHNEIDER	02/18/2014
DAVID WILLIAM BURNS	01/24/2014
SURYAPRAKASH GANTI	01/24/2014

# **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

# PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14137474	

# **CORRESPONDENCE DATA**

**Fax Number**: (716)849-0349 **Phone**: 716-856-4000

Email: rwatt@hodgsonruss.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: HODGSON RUSS LLP/QUALCOMM

Address Line 1: THE GUARANTY BUILDING
Address Line 2: 140 PEARL STREET, SUITE 100
Address Line 4: BUFFALO, NEW YORK 14202-4040

ATTORNEY DOCKET NUMBER:	013325.00275
NAME OF SUBMITTER:	RACHEL S. WATT

PATENT REEL: 032305 FRAME: 0019

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Signature:	/rachel s. watt#46186/
Date:	02/26/2014
Total Attachments: 5 source=Assignment#page1.tif source=Assignment#page2.tif source=Assignment#page3.tif source=Assignment#page4.tif source=Assignment#page5.tif	

# ASSIGNMENT

#### WHEREAS, WE,

- 1. Jack Conway Kitchens II, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714 and a resident of Buffalo, New York,
- 2. John Keith Schneider, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714 and a resident of Williamsville, NY
- 3. David William Burns, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714 and a resident of San Jose, California, and
- 4. Suryaprakash Ganti, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714 and a resident of Los Altos, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to Devices And Methods Of Sensing (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 14/137,474 filed December 20, 2013, Qualcomm Reference No. 133170U2, and all provisional applications relating thereto, together with U.S. Provisional Application Nos. 61/830,548, filed June 3, 2013, Qualcomm Reference No. 133167P1; 61/830,601, filed June 3, 2013, Qualcomm Reference No. 133168P1; and 61/830,606, filed June 3, 2013, Qualcomm Reference No. 133170P1 (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued

patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

PATENT
QUALCOMM Ref. No. 133170U2
Page 3 of 3

Al	ND WE HEREBY CO	ovenant that WE	will not execute any writing or do any ac
whatsoeve	er conflicting with thes	se presents.	<b>N</b>
Done at >	Lahert DY, on	January 24, 20	Jack Conway Kitchens II
	LOCATION	DATE	Jack Conway Kitchens II
Done at _	LOCATION on	DATE	John Keith Schneider
	, on _		
	LOCATION	DATE	David William Burns
Done at _	, on _		
	LOCATION	DATE	Suryaprakash Ganti

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on		
_	LOCATION	DATE	Jack Conway Kitchens II
Done at	Amne (s), on	હ્યોકો હ્યો	Offeneredy
	LOCATION	DATE	John Keith Schneider
Done at	, on _		
-	LOCATION	DATE	David William Burns
Done at	, on		
	LOCATION	DATE	Survaprakash Ganti

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PATENT
QUALCOMM Ref. No. 133170U2
Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on		
	LOCATION	DATE	Jack Conway Kitchens II
Done at _	, on		
	LOCATION	DATE	John Keith Schneider
Done at	alada Clara (A.on	124/2014	Daw a A ama
	LOCATION	DATE	David William Burns
Oone at	<u>Yada Claya (A</u> , on	1/24/2014	
	LOCATION	DATE	Survanrakash Ganti

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RECORDED: 02/26/2014